

SiGe:C Low Noise Amplifier MMIC for GPS, GLONASS, Galileo, and Compass

Rev. 4.2 — 16 May 2019

Product day

Product data sheet

Product profile

1.1 General description

The BGU8019 is, also known as the GPS1202M, a Low Noise Amplifier (LNA) for GNSS receiver applications, available in a small plastic 6-pin extremely thin leadless package. The BGU8019 requires one external matching inductor.

The BGU8019 adapts itself to the changing environment resulting from co-habitation of different radio systems in modern cellular handsets. It has been designed for low power consumption and optimal performance when jamming signals from co-existing cellular transmitters are present. At low jamming power levels it delivers 18.5 dB gain at a noise figure of 0.55 dB. During high jamming power levels, resulting for example from a cellular transmit burst, it temporarily increases its bias current to improve sensitivity.

1.2 Features and benefits

- Cover full GNSS L1 band, from 1559 MHz to 1610 MHz
- Noise figure (NF) = 0.55 dB
- Gain = 18.5 dB
- High input 1 dB compression point of -7 dBm
- High out of band IP3_i of 6 dBm
- Supply voltage 1.5 V to 3.1 V
- Self-shielding package concept
- Integrated supply decoupling capacitor
- Optimized performance at a supply current of 4.6 mA
- Power-down mode current consumption < 1 μA
- Integrated temperature stabilized bias for easy design
- Require only one input matching inductor
- · Input and output DC decoupled
- ESD protection on all pins (HBM > 2 kV)
- Integrated matching for the output
- Available in 6-pins leadless package 1.1 mm × 0.7 mm × 0.37 mm; 0.4 mm pitch: SOT1232
- 180 GHz transit frequency SiGe:C technology
- · Moisture sensitivity level of 1



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1.3 Applications

LNA for GPS, GLONASS, Galileo, and Compass (BeiDou) in:

- smart phones
- · feature phones,
- tablet PCs
- · digital still cameras
- digital video cameras
- RF front-end modules
- · complete GNSS modules
- personal health applications

1.4 Quick reference data

Table 1. Quick reference data

f = 1575 MHz; V_{CC} = 2.85 V; $V_{I(ENABLE)} \ge 0.8$ V; P_i < -40 dBm; T_{amb} = 25 °C; input matched to 50 Ω using a 6.8 nH inductor, see Figure 1; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{CC}	supply voltage			1.5	-	3.1	V
I _{CC}	supply current			-	4.6	-	mA
G _p	power gain	no jammer		-	18.5	-	dB
NF	noise figure	P _i = -40 dBm, no jammer	[1]	-	0.55	-	dB
P _{i(1dB)}	input power at 1 dB gain compression			-	-7	-	dBm
IP3 _i	input third-order intercept point		[2]	-	6	-	dBm

^[1] PCB losses are subtracted. [2] $f_1 = 1713$ MHz; $f_2 = 1851$ MHz; Pi = -20 dBm at f_1 ; Pi = -65 dBm at f_2 .

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2 Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	GND		
2	V _{CC}	4 3	6 2
3	RF_OUT		5—3
4	GND_RF	5 2	1 4
5	RF_IN		aaa-006408
6	ENABLE	6 1	
		Transparent top view	

3 Ordering information

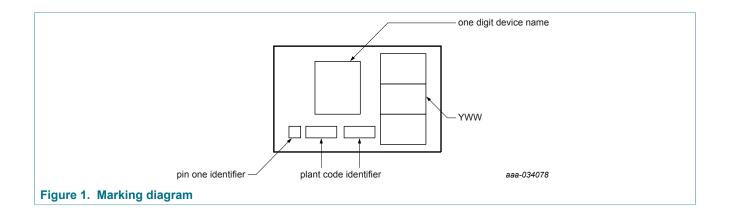
Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
BGU8019	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body $1.1 \times 0.7 \times 0.37$ mm	SOT1232			
OM7848	EVB	BGU8019 evaluation board, MMIC only	-			
OM7849	EVB	BGU8019 evaluation board, front-end EVB	-			

4 Marking code

Table 4. Marking code

- table in marking code						
Type number	Marking code	Date code				
BGU8019	A	YWW				



BGU8019

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5 Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Absolute Maximum Ratings are given as Limiting Values of stress conditions during operation, that must not be exceeded under the worst probable conditions.

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage	RF input AC coupled	[1]	-0.5	+5.0	V
V _{I(ENABLE)}	input voltage on pin ENABLE	V _{I(ENABLE)} < V _{CC} + 0.6 V	[1][2]	-0.5	+5.0	V
$V_{I(RF_IN)}$	input voltage on pin RF_IN	DC, V _{I(RF_IN)} < V _{CC} + 0.6 V	[1][2][3]	-0.5	+5.0	V
$V_{I(RF_OUT)}$	input voltage on pin RF_OUT	DC, V _{I(RF_OUT)} < V _{CC} + 0.6 V	[1][2][3]	-0.5	+5.0	V
Pi	input power		[1]	-	10	dBm
P _{tot}	total power dissipation	T _{sp} ≤ 130 °C		-	55	mW
T _{stg}	storage temperature			-65	+150	°C
Tj	junction temperature			-	150	°C
V _{ESD}	electrostatic discharge voltage	Human Body Model (HBM) According to ANSI/ESDA/JEDEC standard JS-001		-	±2	kV
		Charged Device Model (CDM) According to JEDEC standard JESD22-C101C		-	±1	kV

^[1] Stressed with pulses of 200 ms in duration, with application circuit as in Figure 1.

6 Recommended operating conditions

Table 6. Operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		1.5	-	3.1	V
T _{amb}	ambient temperature		-40	+25	+85	°C
V _{I(ENABLE)}	input voltage on pin ENABLE	OFF state	-	-	0.3	V
		ON state	8.0	-	-	V

7 Thermal characteristics

Table 7. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{th(j-sp)}$	thermal resistance from junction to solder point		225	K/W

^[2] Warning: due to internal ESD diode protection, the applied DC voltage shall not exceed V_{CC} + 0.6 V and shall not exceed 5.0 V in order to avoid excess current.

^[3] The RF input and RF output are AC coupled through internal DC blocking capacitors.

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Characteristics

Table 8. Characteristics at V_{CC} = 1.8 V

 $f = 1575 \; \text{MHz}; \; V_{\text{CC}} = 1.8 \; \text{V}; \; V_{I(ENABLE)} \geq 0.8 \; \text{V}; \; P_{I} < -40 \; \text{dBm}; \; T_{amb} = 25 \; ^{\circ}\text{C}; \; input \; matched \; to \; 50 \; \Omega \; using \; a \; 6.8 \; nH \; inductor, \; denote the contraction of the contraction of$ see Figure 1; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
I _{CC}	supply current	V _{I(ENABLE)} ≥ 0.8 V						
		P _i < -40 dBm		-	4.4	6.4	mA	
		P _i = -20 dBm		-	9	-	mA	
		V _{I(ENABLE)} ≤ 0.3 V		-	-	1	μΑ	
G _p	power gain	no jammer		16	18	20	dB	
		P _{jam} = -20 dBm; f _{jam} = 850 MHz		-	20	-	dB	
		P _{jam} = -20 dBm; f _{jam} = 1850 MHz		-	20	-	dB	
RL _{in}	input return loss	P _i < -40 dBm		9	12	-	dB	
		$P_i = -20 \text{ dBm}$		-	20	-	dB	
RL _{out}	output return loss	P _i < -40 dBm		8	13	-	dB	
		$P_i = -20 \text{ dBm}$		-	12	-	dB	
ISL	isolation			27	30	-	dB	
NF	noise figure	P _i = -40 dBm, no jammer	[1]	-	0.55	1.1	dB	
		P _i = -40 dBm, no jammer	[2]	-	0.60	1.15	dB	
		P _{jam} = -20 dBm; f _{jam} = 850 MHz	[2]	-	0.9	-	dB	
		P _{jam} = -20 dBm; f _{jam} = 1850 MHz	[2]	-	1.3	-	dB	
P _{i(1dB)}	input power at 1 dB gain compression			-13	-10	-	dBm	
IP3 _i	input third-order intercept point	out of band	[3]	-2	2	-	dBm	
		in band	[3]	-10	-6	-	dBm	
IMD3	third-order intermodulation distortion	measured at output pin		-	-89	-	dBm	
t _{on}	turn-on time	time from $V_{I(\text{ENABLE})}$ ON, to 90 % of the gain		-	-	2	μs	
t _{off}	turn-off time	time from $V_{I(ENABLE)}$ OFF, to 10 % of the gain		-	-	1	μs	

PCB losses are subtracted

^[2]

including PCB losses $f_1 = 1713 \text{ MHz}$; $f_2 = 1851 \text{ MHz}$; Pi = -20 dBm at f_1 ; Pi = -65 dBm at f_2 .

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Table 9. Characteristics at V_{CC} = 2.85 V

f = 1575 MHz; V_{CC} = 2.85 V; $V_{I(ENABLE)} \ge 0.8$ V; P_i < -40 dBm; T_{amb} = 25 °C; input matched to 50 Ω using a 6.8 nH inductor, see Figure 1; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I_{CC}	supply current	V _{I(ENABLE)} ≥ 0.8 V					
		P _i < -40 dBm		-	4.6	-	mA
		P _i = -20 dBm		-	10	-	mA
		V _{I(ENABLE)} ≤ 0.3 V		-	-	1	μΑ
G _p	power gain	no jammer		-	18.5	-	dB
		P _{jam} = -20 dBm; f _{jam} = 850 MHz		-	20.0	-	dB
		P _{jam} = -20 dBm; f _{jam} = 1850 MHz		-	20.5	-	dB
RL _{in}	input return loss	P _i < -40 dBm		-	13	-	dB
		P _i = -20 dBm		-	22	-	dB
RL _{out}	output return loss	P _i < -40 dBm		-	13	-	dB
		P _i = -20 dBm		-	12	-	dB
ISL	isolation			-	30	-	dB
NF	noise figure	P _i = -40 dBm, no jammer	[1]	-	0.55	-	dB
		P _i = -40 dBm, no jammer	[2]	-	0.60	-	dB
		P _{jam} = -20 dBm; f _{jam} = 850 MHz	[2]	-	0.9	-	dB
		P _{jam} = -20 dBm; f _{jam} = 1850 MHz	[2]	-	1.3	-	dB
P _{i(1dB)}	input power at 1 dB gain compression			-	-7	-	dBm
IP3 _i	input third-order intercept point		[3]	-	6	-	dBm
IMD3	third-order intermodulation distortion	measured at output pin		-	-96	-	dBm
t _{on}	turn-on time	time from $V_{I(\text{ENABLE})}$ ON, to 90 % of the gain		-	-	2	μs
t _{off}	turn-off time	time from $V_{I(ENABLE)}$ OFF, to 10 % of the gain		-	-	1	μs

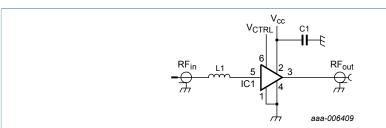
PCB losses are subtracted

 ^[1] PCB losses are subtracted
 [2] Including PCB losses
 [3] f₁ = 1713 MHz; f₂ = 1851 MHz; Pi = -20 dBm at f₁; Pi = -65 dBm at f₂.

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9 Application information

9.1 GNSS application



For a list of components see <u>Table 10</u>.

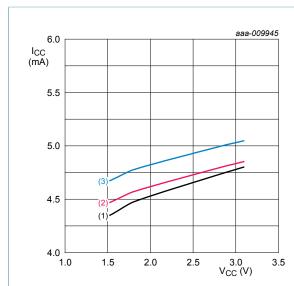
Figure 2. Schematics GNSS evaluation board

Table 10. List of components

For schematics see Figure 1.

Component	Description	Value	Remarks
C1	decoupling capacitor	1 nF	to suppress power supply noise
IC1	BGU8019	-	NXP
L1	high-quality matching inductor	6.8 nH	Murata LQW15A

9.2 Graphs



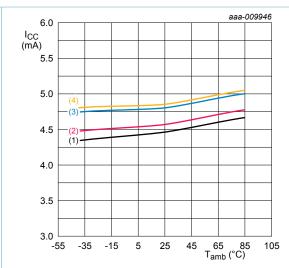
 $P_i = -45 \text{ dBm}.$

1. $T_{amb} = -40 \, ^{\circ}C$

2. $T_{amb} = +25 \,^{\circ}C$

3. $T_{amb} = +85 \, ^{\circ}C$

Figure 3. Supply current as a function of supply voltage; typical values



 $P_i = -45 \text{ dBm}.$

1. $V_{CC} = 1.5 V$

2. $V_{CC} = 1.8 \text{ V}$

3. $V_{CC} = 2.85 \text{ V}$

4. $V_{CC} = 3.1 \text{ V}$

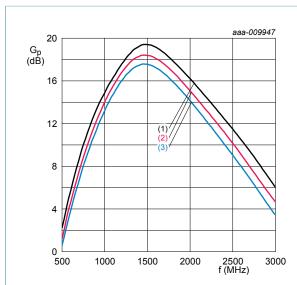
Figure 4. Supply current as a function of ambient temperature; typical values

BGU8019

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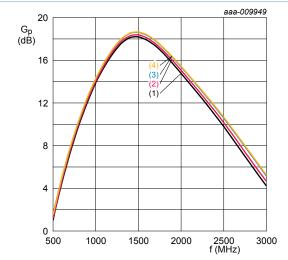


$$P_i$$
 = -45 dBm; V_{CC} = 1.8 V.

1.
$$T_{amb} = -40 \, ^{\circ}C$$

2.
$$T_{amb} = +25 \, ^{\circ}C$$





 P_i = -45 dBm; T_{amb} = 25 °C.

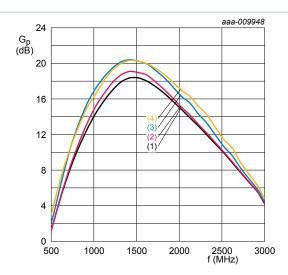
1.
$$V_{CC} = 1.5 V$$

2.
$$V_{CC} = 1.8 \text{ V}$$

3.
$$V_{CC} = 2.85 \text{ V}$$

4. $V_{CC} = 3.1 \text{ V}$

Figure 7. Power gain as a function of frequency; typical values



$$T_{amb} = 25 \, ^{\circ}C; \, V_{CC} = 1.8 \, V.$$

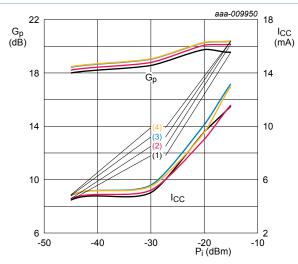
1.
$$P_i = -45 \text{ dBm}$$

2.
$$P_i = -30 \text{ dBm}$$

3.
$$P_i = -20 \text{ dBm}$$

4.
$$P_i = -15 \text{ dBm}$$

Figure 6. Power gain as a function of frequency; typical values



 $f = 1575 \text{ MHz}; T_{amb} = 25 ^{\circ}\text{C}.$

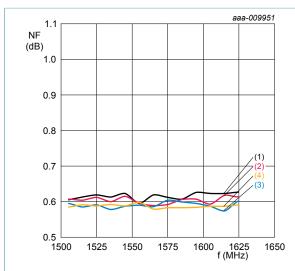
1.
$$V_{CC} = 1.5 V$$

3.
$$V_{CC} = 2.85 V$$

4. V_{CC} = 3.1 V

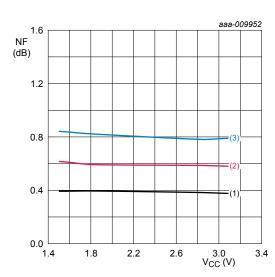
Figure 8. Power gain and supply current as function of input power; typical values

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 T_{amb} = 25 °C; no jammer, including PCB losses.

- 1. $V_{CC} = 1.5 V$
- 2. $V_{CC} = 1.8 \text{ V}$
- 3. $V_{CC} = 2.85 \text{ V}$
- 4. $V_{CC} = 3.1 \text{ V}$

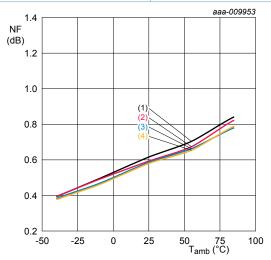


f = 1575 MHz; no jammer, including PCB losses.

- 1. $T_{amb} = -40 \, ^{\circ}C$
- 2. T_{amb} = +25 °C
- 3. $T_{amb} = +85 \, ^{\circ}C$

values

Figure 9. Noise figure as a function of frequency; typical Figure 10. Noise figure as a function of supply voltage; typical values

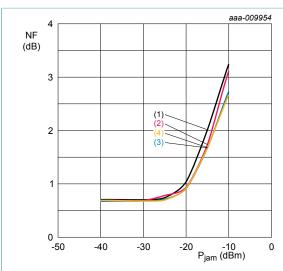


f = 1575 MHz; no jammer, including PCB losses.

- 1. $V_{CC} = 1.5 V$
- 2. $V_{CC} = 1.8 \text{ V}$
- 3. $V_{CC} = 2.85 \text{ V}$
- 4. $V_{CC} = 3.1 \text{ V}$

Figure 11. Noise figure as a function of ambient temperature; typical values

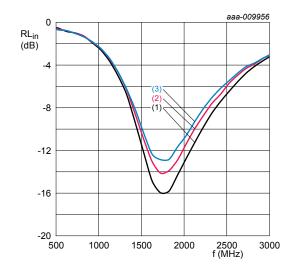
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 f_{jam} = 850 MHz; T_{amb} = 25 °C; f = 1575 MHz; including PCB losses.

- 1. $V_{CC} = 1.5 V$
- 2. $V_{CC} = 1.8 \text{ V}$
- 3. $V_{CC} = 2.85 \text{ V}$
- 4. $V_{CC} = 3.1 \text{ V}$

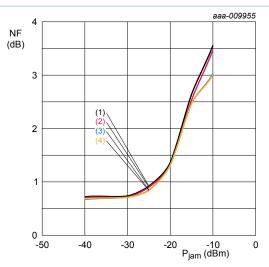
Figure 12. Noise figure as a function of jamming power; typical values



 $P_i = -45 \text{ dBm}; V_{CC} = 1.8 \text{ V}.$

- 1. $T_{amb} = -40 \, ^{\circ}C$
- 2. $T_{amb} = +25 \, ^{\circ}C$
- 3. $T_{amb} = +85 \, ^{\circ}C$

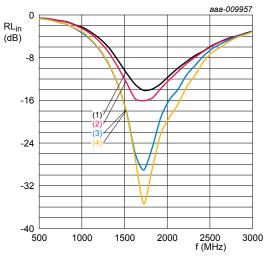
Figure 14. Input return loss as a function of frequency; typical values



 f_{jam} = 1850 MHz; T_{amb} = 25 °C; f = 1575 MHz; including PCB losses.

- 1. $V_{CC} = 1.5 V$
- 2. $V_{CC} = 1.8 \text{ V}$
- 3. $V_{CC} = 2.85 \text{ V}$
- 4. $V_{CC} = 3.1 \text{ V}$

Figure 13. Noise figure as a function of jamming power; typical values

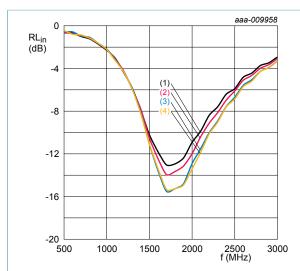


 T_{amb} = 25 °C; V_{CC} = 1.8 V.

- 1. $P_i = -45 \text{ dBm}$
- 2. $P_i = -30 \text{ dBm}$
- 3. $P_i = -20 \text{ dBm}$
- 4. $P_i = -15 \text{ dBm}$

Figure 15. Input return loss as a function of frequency; typical values

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$$P_i$$
 = -45 dBm; T_{amb} = 25 °C.

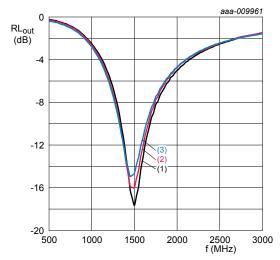
1.
$$V_{CC} = 1.5 V$$

2.
$$V_{CC} = 1.8 \text{ V}$$

3.
$$V_{CC} = 2.85 \text{ V}$$

4.
$$V_{CC} = 3.1 \text{ V}$$

Figure 16. Input return loss as a function of frequency; typical values



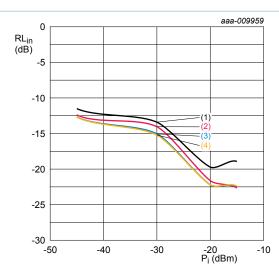
 $P_i = -45 \text{ dBm}; V_{CC} = 1.8 \text{ V}.$

1.
$$T_{amb} = -40 \, ^{\circ}C$$

2.
$$T_{amb} = +25 \, ^{\circ}C$$

3.
$$T_{amb} = +85 \,^{\circ}C$$

Figure 18. Output return loss as a function of frequency; typical values



 $f = 1575 \text{ MHz}; T_{amb} = 25 ^{\circ}\text{C}.$

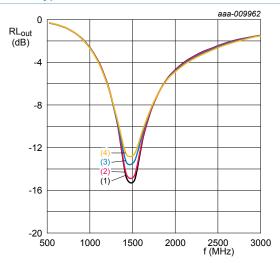
1.
$$V_{CC} = 1.5 V$$

2.
$$V_{CC} = 1.8 \text{ V}$$

3.
$$V_{CC} = 2.85 \text{ V}$$

4.
$$V_{CC} = 3.1 \text{ V}$$

Figure 17. Input return loss as a function of input power; typical values



 T_{amb} = 25 °C; V_{CC} = 1.8 V.

1.
$$P_i = -45 \text{ dBm}$$

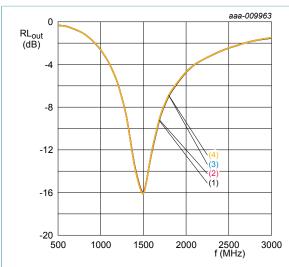
2.
$$P_i = -30 \text{ dBm}$$

3.
$$P_i = -20 \text{ dBm}$$

4.
$$P_i = -15 \text{ dBm}$$

Figure 19. Output return loss as a function of frequency; typical values

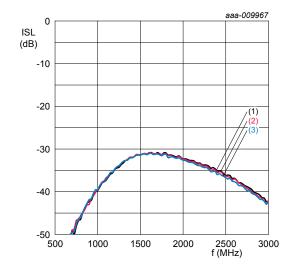
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$$P_i$$
 = -45 dBm; T_{amb} = 25 °C.

- 1. $V_{CC} = 1.5 V$
- 2. $V_{CC} = 1.8 \text{ V}$
- 3. $V_{CC} = 2.85 \text{ V}$
- 4. $V_{CC} = 3.1 \text{ V}$

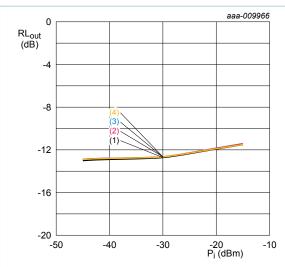
Figure 20. Output return loss as a function of frequency; typical values



 P_i = -45 dBm; V_{CC} = 1.8 V.

- 1. $T_{amb} = -40 \, ^{\circ}C$
- 2. $T_{amb} = +25 \, ^{\circ}C$
- 3. $T_{amb} = +85 \,^{\circ}C$

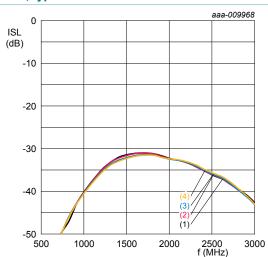
Figure 22. Isolation as a function of frequency; typical values



 $f = 1575 \text{ MHz}; T_{amb} = 25 ^{\circ}\text{C}.$

- 1. $V_{CC} = 1.5 V$
- 2. $V_{CC} = 1.8 \text{ V}$
- 3. $V_{CC} = 2.85 \text{ V}$
- 4. $V_{CC} = 3.1 \text{ V}$

Figure 21. Output return loss as a function of input power; typical values

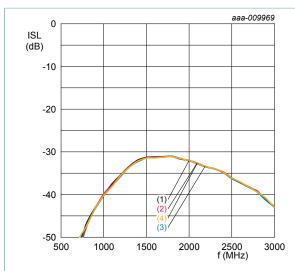


 T_{amb} = 25 °C; V_{CC} = 1.8 V.

- 1. P_i = -45 dBm
- 2. $P_i = -30 \text{ dBm}$
- 3. $P_i = -20 \text{ dBm}$
- 4. $P_i = -15 \text{ dBm}$

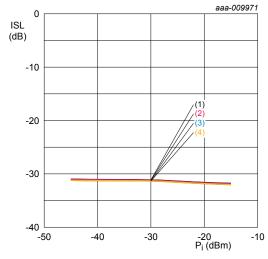
Figure 23. Isolation as a function of frequency; typical values

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 P_i = -45 dBm; T_{amb} = 25 °C.

- 1. $V_{CC} = 1.5 V$
- 2. $V_{CC} = 1.8 \text{ V}$
- 3. $V_{CC} = 2.85 \text{ V}$
- 4. $V_{CC} = 3.1 \text{ V}$

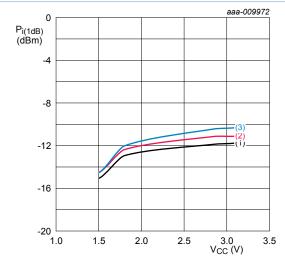


 $f = 1575 \text{ MHz}; T_{amb} = 25 ^{\circ}\text{C}.$

- 1. $V_{CC} = 1.5 V$
- 2. $V_{CC} = 1.8 \text{ V}$
- 3. $V_{CC} = 2.85 \text{ V}$
- 4. $V_{CC} = 3.1 \text{ V}$

Figure 24. Isolation as a function of frequency; typical values

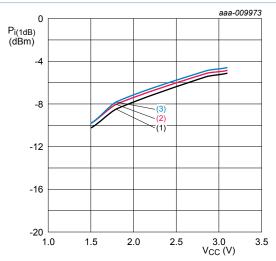




f = 850 MHz.

- 1. $T_{amb} = -40 \, ^{\circ}C$
- 2. $T_{amb} = +25 \, ^{\circ}C$
- 3. $T_{amb} = +85 \, ^{\circ}C$

Figure 26. Input power at 1 dB gain compression as a function of supply voltage; typical values

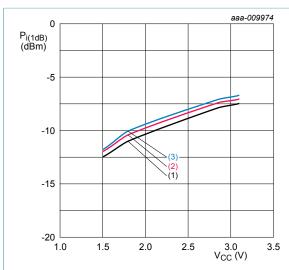


f = 1850 MHz.

- 1. $T_{amb} = -40 \, ^{\circ}C$
- 2. T_{amb} = +25 °C
- 3. T_{amb} = +85 °C

Figure 27. Input power at 1 dB gain compression as a function of supply voltage; typical values

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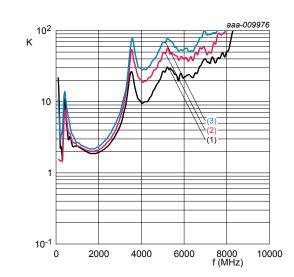
f = 1575 MHz.

1.
$$T_{amb} = -40 \, ^{\circ}C$$

2.
$$T_{amb} = +25 \, ^{\circ}C$$

3.
$$T_{amb} = +85 \, ^{\circ}C$$

Figure 28. Input power at 1 dB gain compression as a function of supply voltage; typical values



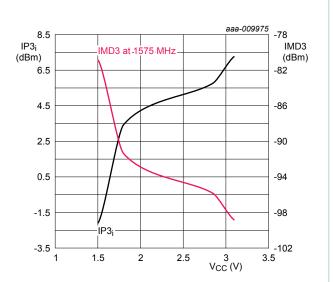
 $P_i = -45 \text{ dBm}$; $V_{CC} = 1.8 \text{ V}$.

1.
$$T_{amb} = -40 \, ^{\circ}C$$

2.
$$T_{amb} = +25 \, ^{\circ}C$$

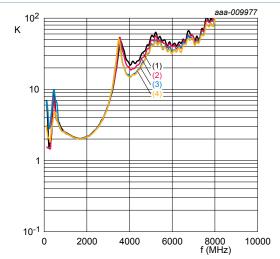
3.
$$T_{amb} = +85 \, ^{\circ}C$$

Figure 30. Rollett stability factor as a function of frequency; typical values



 f_1 = 1713 MHz; f_2 = 1851 MHz; Pi = -20 dBm at f_1 ; Pi = -65 dBm at f_2 ; T_{amb} = 25 °C.

Figure 29. Input third order intercept point and third order intermodulation distortion as function of supply voltage; typical values



 P_i = -45 dBm; T_{amb} = 25 °C.

1.
$$V_{CC} = 1.5 V$$

2.
$$V_{CC} = 1.8 \text{ V}$$

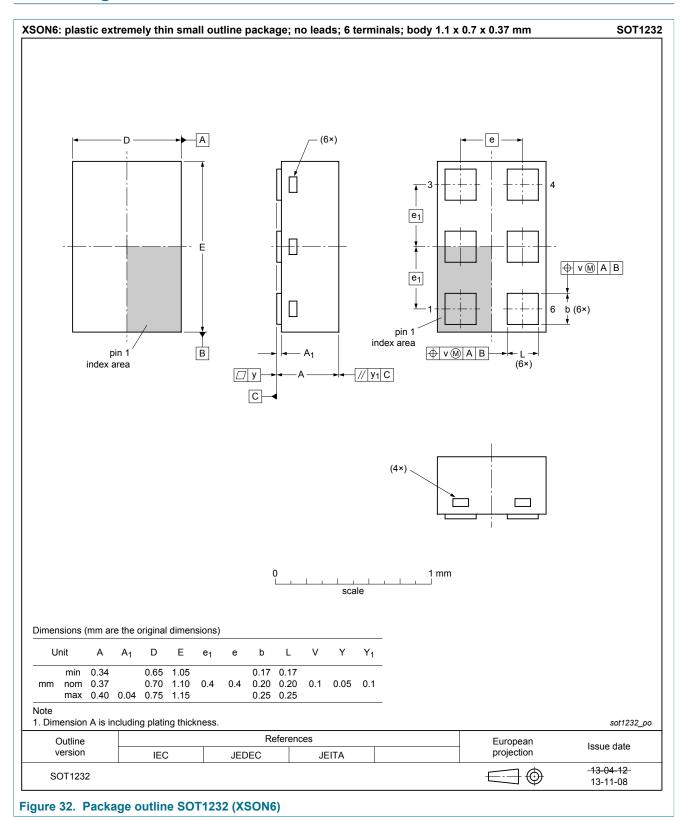
3.
$$V_{CC} = 2.85 \text{ V}$$

4.
$$V_{CC} = 3.1 \text{ V}$$

Figure 31. Rollett stability factor as a function of frequency; typical values

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10 Package outline



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11 Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices. Such precautions are described in the *ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A* or equivalent standards.

12 Abbreviations

Table 11. Abbreviations

Acronym	Description
ESD	electrostatic discharge
GLONASS	global navigation satellite system
GNSS	global navigation satellite system
GPS	global positioning system
НВМ	human body model
MMIC	monolithic microwave-integrated circuit
PCB	printed circuit board
SiGe:C	silicon germanium carbon

13 Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
BGU8019 v.4.2	20190516	Product data sheet	-	BGU8019 v.4.1			
Modifications:	added general Marking diagram						
BGU8019 v.4.1	20190510	Product data sheet	-	BGU8019 v.4			
Modifications:	adapted date code notation to the Marking code table						
BGU8019 v.4	20181123	Product data sheet	-	BGU8019 v.3			
Modifications:	 adapted in band, 	min and max values in the c and out of band condition to ne of the application into GN	IP3 _i parameter				
BGU8019 v.3	20170118	Product data sheet	-	BGU8019 v.2			
Modifications:	<u>Section 1</u> : added GPS1202M according to our new naming convention						
BGU8019 v.2	20140603	Product data sheet	-	BGU8019 v.1			
BGU8019 v.1	20131112	Preliminary data sheet	-	-			

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14 Legal information

14.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- The term 'short data sheet' is explained in section "Definitions".
- [2] [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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